



Report: APR-21-H0673-A  
Date: 28/Feb./2023

# RENESAS SEMICONDUCTOR RELIABILITY REPORT

SERIES: RV1S2211A

DEVICE: RV1S2211ACCSP-10YC#KC0  
RV1S2211ACCSP-10YC#SC0  
RV1S2211ACCSP-10YV#KC0  
RV1S2211ACCSP-10YV#SC0

APPLICATION: Standard

Quality Assurance Division  
Renesas Electronics Corporation

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## Reliability test result

| Test Items                                    | Reference              | Test Conditions   | Results<br>Reject/Size |
|---|------------------------|---|------------------------|
| High Temperature Storage Life                 | JESD22-A103            | Ta=125°C, t=1000h   | 0/22                   |
| Temperature Humidity Bias (HAST)              | JESD22-A110            | Ta=130°C, RH=85%, VCE=40V, t=96h  | 0/20                   |
| High Temperature Operating Life               | JESD22-A108            | Ta=115°C, IF=Maximum current within Diode Power Dissipation rating, t=1000h                     | 0/20                   |
| Unbiased Temperature Humidity (Unbiased HAST) | JESD22-A118            | Ta=130°C, RH=85%, t=96h   | 0/22                   |
| Temperature Cycling                           | JESD22-A104            | -40°C~125°C, 850cycles  | 0/22                   |
| Electrostatic discharge (HBM Method)          | JS-001                 | C=100pF, 1.5kΩ, 2000V   | 0/5                    |
| Electrostatic discharge (CDM Method)          | JESD22-C101            | 500V  | 0/5                    |
| Solderability                                 | J-STD-002              | 245°C,5s Wet area 95% or more   | 0/22                   |
| Resistance to Soldering Heat                  | JESD22-A113, J-STD-020 | Bake: 125°C, 24h<br>Moisture Soak:85°C85%RH, 168h(MSL=1)<br>Reflow:260°Cmax, 255°Cx30s, 3times) | 0/22                   |
| Estimated Failure Rate                        | -                      | Estimated failure rate: 10Fit<br>Ta= 55°C, Ea=0.7eV, C.L.=60%                                   |                        |

MSL Preconditioning was performed prior to Temperature humidity bias, Unbiased Temperature Humidity and Temperature cycling.

Preconditioning Details: 125°C,24h→85°C,85%RH,168h→Reflow260°Cmax, 255°Cx30s,3times)

Reliability test results may include data from family representative products.

Criteria shall follow the electrical characteristics in Specifications, except for Solderability.

However, ΔCTR shall be the initial value ± 50%.